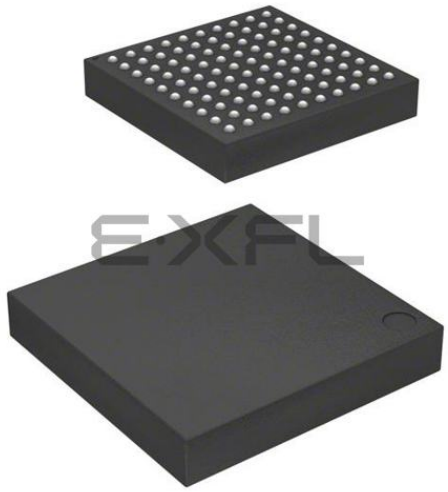
Renesas Electronics America Inc - R5F52317BDLA#20 Datasheet



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, SCI, SD/SDIO, SPI, SSI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	79
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 24x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (5.5x5.5)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52317bdla-20

Table 1.1 Outline of Specifications (2/4)

Classification	Module/Function	Description
Low power consumption	Low power consumption functions	• Module stop function • Three low power consumption modes Sleep mode, deep sleep mode, and software standby mode • Low power timer that operates during the software standby state
	Function for lower operating power consumption	• Operating power control modes High-speed operating mode, middle-speed operating mode, and low-speed operating mode
Interrupt	Interrupt controller (ICUb)	• Interrupt vectors: 167 • External interrupts: 9 (NMI, IRQ0 to IRQ7 pins) • Non-maskable interrupts: 7 (NMI pin, oscillation stop detection interrupt, voltage monitoring 1 interrupt, voltage monitoring 2 interrupt, WDT interrupt, IWDT interrupt, and VBATT power monitoring interrupt) • 16 levels specifiable for the order of priority
External bus extension		• The external address space can be divided into four areas (CS0 to CS3), each with independent control of access settings. Capacity of each area: 16 Mbytes (CS0 to CS3) A chip-select signal (CS0# to CS3#) can be output for each area. Each area is specifiable as an 8-bit or 16-bit bus space The data arrangement in each area is selectable as little or big endian (only for data). Bus format: Separate bus, multiplex bus • Wait control • Write buffer facility
DMA	DMA controller (DMACA)	• 4 channels • Three transfer modes: Normal transfer, repeat transfer, and block transfer • Activation sources: Software trigger, external interrupts, and interrupt requests from peripheral functions
	Data transfer controller (DTCa)	• Transfer modes: Normal transfer, repeat transfer, and block transfer • Activation sources: Interrupts • Chain transfer function
I/O ports	General I/O ports	100-pin/64-pin/48-pin I/O: 79/43/30 (RX231 Group), 83/47/34 (RX230 Group) • Input: 1/1/1 Pull-up resistors: 79/43/30(RX231 Group), 83/47/34 (RX230 Group) • Open-drain outputs: 58/34/26 • 5-V tolerance: 8/5/5
Event link controller (ELC)		• Event signals of 61 types can be directly connected to the module • Operations of timer modules are selectable at event input • Capable of event link operation for port B and port E
Multi-function pin controller (MPC)		Capable of selecting the input/output function from multiple pins
Timers	16-bit timer pulse unit (TPUa)	• (16 bits × 6 channels) × 1 unit • Maximum of 16 pulse-input/output possible • Select from among seven or eight counter-input clock signals for each channel • Supports the input capture/output compare function • Output of PWM waveforms in up to 15 phases in PWM mode • Support for buffered operation, phase-counting mode (two-phase encoder input) and cascade connected operation (32 bits × 2 channels) depending on the channel. • Capable of generating conversion start triggers for the A/D converters • Signals from the input capture pins are input via a digital filter • Clock frequency measuring method
	Multi-function timer pulse unit 2 (MTU2a)	• (16 bits × 6 channels) × 1 unit • Up to 16 pulse-input/output lines and three pulse-input lines are available based on the six 16-bit timer channels • Select from among eight or seven counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, PCLK/256, PCLK/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available. • Input capture function • 21 output compare/input capture registers • Pulse output mode • Complementary PWM output mode • Reset synchronous PWM mode • Phase-counting mode • Capable of generating conversion start triggers for the A/D converter
	Port output enable 2 (POE2a)	Controls the high-impedance state of the MTU's waveform output pins
	Compare match timer (CMT)	• (16 bits × 2 channels) × 2 units • Select from among four clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Watchdog timer (WDTA)	• 14 bits x 1 channel • Select from among six counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192)

1.4 Pin Functions

Table 1.5 lists the pin functions.

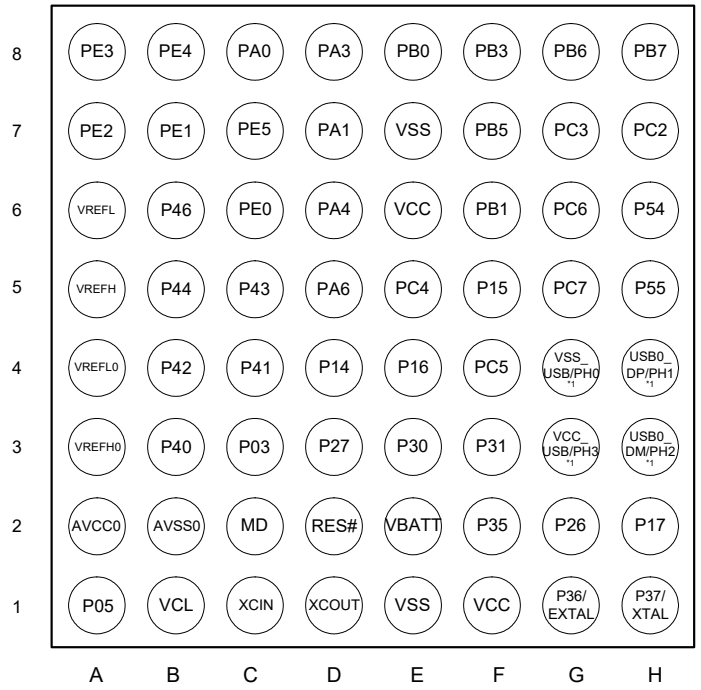
Table 1.5 Pin Functions (1/4)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply.
	VCL	—	Connect this pin to the VSS pin via a 4.7 μF smoothing capacitor used to stabilize the internal power supply. Place the capacitor close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VBATT	Input	Backup power pin
Clock	XTAL	Output	Pins for connecting a crystal. An external clock can be input through the EXTAL pin.
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices.
	XCIN	Input	Input/output pins for the sub-clock oscillator. Connect a crystal between XCIN and XCOUT.
	XCOUT	Output	
	CLKOUT	Output	Clock output pin.
Operating mode control	MD	Input	Pin for setting the operating mode. The signal levels on this pin must not be changed during operation.
	UB	Input	Pin used for boot mode (USB interface).
	UPSEL	Input	Pin used for boot mode (USB interface).
System control	RES#	Input	Reset pin. This MCU enters the reset state when this signal goes low.
CAC	CACREF	Input	Input pin for the clock frequency accuracy measurement circuit.
On-chip emulator	FINED	I/O	FINE interface pin.
Address bus	A0 to A23	Output	Output pins for the address.
Data bus	D0 to D15	I/O	Input and output pins for the bidirectional data bus.
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in single-write strobe mode.
	WR0#, WR1#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, and D15 to D8) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0#, BC1#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0 and D15 to D8) is valid in access to the external bus interface space, in single-write strobe mode.
	CS0# to CS3#	Output	Select signals for areas 0 to 3.
	WAIT#	Input	Input pin for wait request signals in access to the external space.
	ALE	Output	Address latch signal when address/data multiplexed bus is selected.
LVD	CMPA2	Input	Detection target voltage pin for voltage detection 2.
Interrupts	NMI	Input	Non-maskable interrupt request pin.
	IRQ0 to IRQ7	Input	Interrupt request pins.

Table 1.5 Pin Functions (2/4)

Classifications	Pin Name	I/O	Description
16-bit timer pulse unit	TIOCA0, TIOCB0 TIOCC0, TIOCD0	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	TIOCA1, TIOCB1	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	TIOCA2, TIOCB2	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	TIOCA3, TIOCB3 TIOCC3, TIOCD3	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	TIOCA4, TIOCB4	I/O	The TGRA4 and TGRB4 input capture input/output compare output/PWM output pins.
	TIOCA5, TIOCB5	I/O	The TGRA5 and TGRB5 input capture input/output compare output/PWM output pins.
	TCLKA, TCLKB TCLKC, TCLKD	Input	Input pins for external clock signals.
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V, MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/external pulse input pins.
	MTCLKA, MTCLKB, MTCLKC, MTCLKD	Input	Input pins for the external clock.
Port output enable 2	POE0# to POE3#, POE8#	Input	Input pins for request signals to place the MTU pins in the high impedance state.
Realtime clock	RTCOUT	Output	Output pin for the 1-Hz/64-Hz clock.
	RTCIC0 to RTCIC2	Input	Time capture event input pins.
8-bit timer	TMO0 to TMO3	Output	Compare match output pins.
	TMCI0 to TMCI3	Input	Input pins for the external clock to be input to the counter.
	TMRI0 to TMRI3	Input	Counter reset input pins.
Serial communications interface (SCIg)	• Asynchronous mode/clock synchronous mode		
	SCK0, SCK1, SCK5, SCK6, SCK8, SCK9	I/O	Input/output pins for the clock.
	RXD0, RXD1, RXD5, RXD6, RXD8, RXD9	Input	Input pins for received data.
	TXD0, TXD1, TXD5, TXD6, TXD8, TXD9	Output	Output pins for transmitted data.
	CTS0#, CTS1#, CTS5#, CTS6#, CTS8#, CTS9#	Input	Input pins for controlling the start of transmission and reception.
	RTS0#, RTS1#, RTS5#, RTS6#, RTS8#, RTS9#	Output	Output pins for controlling the start of transmission and reception.
	• Simple I^2C mode		
	SSCL0, SSCL1, SSCL5, SSCL6, SSCL8, SSCL9	I/O	Input/output pins for the I^2C clock.
	SSDA0, SSDA1, SSDA5, SSDA6, SSDA8, SSDA9	I/O	Input/output pins for the I^2C data.

RX230 Group, RX231 Group
PWLG0064KA-A
(64-pin WFLGA)
(Upper perspective view)



Note: This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table “List of Pins and Pin Functions (64-Pin WFLGA)”.
Note: For the position of A1 pin in the package, see “Package Dimensions”.
Note 1. RX230: PH0, PH1, PH2, PH3
RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

Figure 1.5 Pin Assignments of the 64-Pin WFLGA

Table 1.9 List of Pins and Pin Functions (64-Pin LFQFP/HWQFN) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
1		P03					DA0
2	VCL						
3	MD						FINED
4	XCIN						
5	XCOUT						
6	RES#						
7	XTAL	P37					
8	VSS						
9	EXTAL	P36					
10	VCC						
11	UPSEL	P35					NMI
12	VBATT						
13		P31	MTIOC4D/TMCI2/RTCIC1	CTS1#/RTS1#/SS1#/SSISCK0			IRQ1
14		P30	MTIOC4B/TMRI3/POE8#/RTCIC0	RXD1/SMISO1/SSCL1/ AUDIO_MCLK			IRQ0/CMPOB3
15		P27	MTIOC2B/TMCI3	SCK1/SSIWS0		TS2	CVREFB3
16		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN/SSIRXD0		TS3	CMPB3
17		P17	MTIOC3A/MTIOC3B/TMO1/ POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/SSITXD0			IRQ7/ CMPOB2
18		P16	MTIOC3C/MTIOC3D/TMO2/ TIOCB1/TCLKC/RTCOUT	TXD1/SMOSI1/SSDA1/MOSIA/ SCL/USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB			IRQ6/ADTRG0#
19		P15	MTIOC0B/MTCLKB/TMCI2/ TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/CRXD0		TS12	IRQ5/CMPB2
20		P14	MTIOC3A/MTCLKA/TMRI2/ TIOCB5/TCLKA	CTS1#/RTS1#/SS1#/CTXD0/ USB0_OVRCURA		TS13	IRQ4/CVREFB2
21	VCC_USB*1	PH3*1	TMCI0*1				
22		PH2*1	TMRI0*1	USB0_DM*1			IRQ1*1
23		PH1*1	TMO0*1	USB0_DP*1			IRQ0*1
24	VSS_USB*1	PH0*1					CACREF*1
25		P55	MTIOC4D/TMO3	CRXD0		TS15	
26		P54	MTIOC4B/TMCI1	CTXD0		TS16	
27	UB	PC7	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/MISOA			CACREF
28		PC6	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/MOSIA/ USB0_EXICEN		TS22	
29		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA/USB0_ID		TS23	
30		PC4	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0	SDHI_D1	TSCAP	
31		PC3	MTIOC4D/TCLKB	TXD5/SMOSI5/SSDA5/ IRTXD5	SDHI_D0	TS27	
32		PC2	MTIOC4B/TCLKA	RXD5/SMISO5/SSCL5/SSLA3/ IRRXD5	SDHI_D3	TS30	
33		PB7/PC1	MTIOC3B/TIOCB5	TXD9/SMOSI9/SSDA9	SDHI_D2		
34		PB6/PC0	MTIOC3D/TIOCA5	RXD9/SMISO9/SSCL9	SDHI_D1		
35		PB5	MTIOC2A/MTIOC1B/TMRI1/ POE1#/TIOCB4	SCK9/USB0_VBUS	SDHI_CD		
36		PB3	MTIOC0A/MTIOC4A/TMO0/ POE3#/TIOCD3/TCLKD	SCK6	SDHI_WP		
37		PB1	MTIOC0C/MTIOC4C/TMCI0/ TIOCB3	TXD6/SMOSI6/SSDA6	SDHI_CLK		IRQ4/ CMPOB1
38	VCC						
39		PB0	MTIC5W/TIOCA3	RXD6/SMISO6/SSCL6/RSPCKA	SDHI_CMD		
40	VSS						
41		PA6	MTIC5V/MTCLKB/TMCI3/POE2#/ TIOCA2	CTS5#/RTS5#/SS5#/MOSIA/ SSIWS0			

Table 1.10 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
42		P42					AN002
43		P41					AN001
44	VREFL0						
45		P40					AN000
46	VREFH0						
47	AVCC0						
48	AVSS0						

Note 1. RX230: PH0/CACREF, PH1/IRQ0/TMO0, PH2/IRQ1/TMRI0, PH3/TMCI0
RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

Table 4.1 List of I/O Registers (Address Order) (14/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 B003h	CAC	CAC Interrupt Request Enable Register	CAICR	8	8	2 or 3 PCLKB	2 ICLK
0008 B004h	CAC	CAC Status Register	CASTR	8	8	2 or 3 PCLKB	2 ICLK
0008 B006h	CAC	CAC Upper-Limit Value Setting Register	CAULVR	16	16	2 or 3 PCLKB	2 ICLK
0008 B008h	CAC	CAC Lower-Limit Value Setting Register	CALLVR	16	16	2 or 3 PCLKB	2 ICLK
0008 B00Ah	CAC	CAC Counter Buffer Register	CACNTBR	16	16	2 or 3 PCLKB	2 ICLK
0008 B080h	DOC	DOC Control Register	DOCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B082h	DOC	DOC Data Input Register	DODIR	16	16	2 or 3 PCLKB	2 ICLK
0008 B084h	DOC	DOC Data Setting Register	DODSR	16	16	2 or 3 PCLKB	2 ICLK
0008 B100h	ELC	Event Link Control Register	ELCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B102h	ELC	Event Link Setting Register 1	ELSR1	8	8	2 or 3 PCLKB	2 ICLK
0008 B103h	ELC	Event Link Setting Register 2	ELSR2	8	8	2 or 3 PCLKB	2 ICLK
0008 B104h	ELC	Event Link Setting Register 3	ELSR3	8	8	2 or 3 PCLKB	2 ICLK
0008 B105h	ELC	Event Link Setting Register 4	ELSR4	8	8	2 or 3 PCLKB	2 ICLK
0008 B108h	ELC	Event Link Setting Register 7	ELSR7	8	8	2 or 3 PCLKB	2 ICLK
0008 B109h	ELC	Event Link Setting Register 8	ELSR8	8	8	2 or 3 PCLKB	2 ICLK
0008 B10Bh	ELC	Event Link Setting Register 10	ELSR10	8	8	2 or 3 PCLKB	2 ICLK
0008 B10Dh	ELC	Event Link Setting Register 12	ELSR12	8	8	2 or 3 PCLKB	2 ICLK
0008 B10Fh	ELC	Event Link Setting Register 14	ELSR14	8	8	2 or 3 PCLKB	2 ICLK
0008 B110h	ELC	Event Link Setting Register 15	ELSR15	8	8	2 or 3 PCLKB	2 ICLK
0008 B111h	ELC	Event Link Setting Register 16	ELSR16	8	8	2 or 3 PCLKB	2 ICLK
0008 B113h	ELC	Event Link Setting Register 18	ELSR18	8	8	2 or 3 PCLKB	2 ICLK
0008 B114h	ELC	Event Link Setting Register 19	ELSR19	8	8	2 or 3 PCLKB	2 ICLK
0008 B115h	ELC	Event Link Setting Register 20	ELSR20	8	8	2 or 3 PCLKB	2 ICLK
0008 B116h	ELC	Event Link Setting Register 21	ELSR21	8	8	2 or 3 PCLKB	2 ICLK
0008 B117h	ELC	Event Link Setting Register 22	ELSR22	8	8	2 or 3 PCLKB	2 ICLK
0008 B118h	ELC	Event Link Setting Register 23	ELSR23	8	8	2 or 3 PCLKB	2 ICLK
0008 B119h	ELC	Event Link Setting Register 24	ELSR24	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Ah	ELC	Event Link Setting Register 25	ELSR25	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Bh	ELC	Event Link Setting Register 26	ELSR26	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Ch	ELC	Event Link Setting Register 27	ELSR27	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Dh	ELC	Event Link Setting Register 28	ELSR28	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Eh	ELC	Event Link Setting Register 29	ELSR29	8	8	2 or 3 PCLKB	2 ICLK
0008 B11Fh	ELC	Event Link Option Setting Register A	ELOPA	8	8	2 or 3 PCLKB	2 ICLK
0008 B120h	ELC	Event Link Option Setting Register B	ELOPB	8	8	2 or 3 PCLKB	2 ICLK
0008 B121h	ELC	Event Link Option Setting Register C	ELOPC	8	8	2 or 3 PCLKB	2 ICLK
0008 B122h	ELC	Event Link Option Setting Register D	ELOPD	8	8	2 or 3 PCLKB	2 ICLK
0008 B123h	ELC	Port Group Setting Register 1	PGR1	8	8	2 or 3 PCLKB	2 ICLK
0008 B124h	ELC	Port Group Setting Register 2	PGR2	8	8	2 or 3 PCLKB	2 ICLK
0008 B125h	ELC	Port Group Control Register 1	PGC1	8	8	2 or 3 PCLKB	2 ICLK
0008 B126h	ELC	Port Group Control Register 2	PGC2	8	8	2 or 3 PCLKB	2 ICLK
0008 B127h	ELC	Port Buffer Register 1	PDBF1	8	8	2 or 3 PCLKB	2 ICLK
0008 B128h	ELC	Port Buffer Register 2	PDBF2	8	8	2 or 3 PCLKB	2 ICLK
0008 B129h	ELC	Event Link Port Setting Register 0	PEL0	8	8	2 or 3 PCLKB	2 ICLK
0008 B12Ah	ELC	Event Link Port Setting Register 1	PEL1	8	8	2 or 3 PCLKB	2 ICLK
0008 B12Bh	ELC	Event Link Port Setting Register 2	PEL2	8	8	2 or 3 PCLKB	2 ICLK
0008 B12Ch	ELC	Event Link Port Setting Register 3	PEL3	8	8	2 or 3 PCLKB	2 ICLK
0008 B12Dh	ELC	Event Link Software Event Generation Register	ELSEGR	8	8	2 or 3 PCLKB	2 ICLK
0008 B300h	SCI12	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 B301h	SCI12	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 B302h	SCI12	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B303h	SCI12	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 B304h	SCI12	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (16/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 C023h	PORT3	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C024h	PORT4	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C025h	PORT5	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C02Ah	PORTA	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C02Bh	PORTB	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C02Ch	PORTC	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C02Dh	PORTD	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C02Eh	PORTE	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C031h	PORTH	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C032h	PORTJ	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C040h	PORT0	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C041h	PORT1	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C042h	PORT2	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C043h	PORT3	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C044h	PORT4	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C045h	PORT5	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C04Ah	PORTA	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C04Bh	PORTB	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C04Ch	PORTC	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C04Dh	PORTD	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C04Eh	PORTE	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C051h	PORTH	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C052h	PORTJ	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB	3 ICLK
0008 C060h	PORT0	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C061h	PORT1	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C062h	PORT2	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C063h	PORT3	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C064h	PORT4	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C065h	PORT5	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C06Ah	PORTA	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C06Bh	PORTB	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C06Ch	PORTC	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C06Dh	PORTD	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C06Eh	PORTE	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C071h	PORTH	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C072h	PORTJ	Port Mode Register	PMR	8	8	2 or 3 PCLKB	2 ICLK
0008 C082h	PORT1	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C083h	PORT1	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C084h	PORT2	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C085h	PORT2	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C086h	PORT3	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C087h	PORT3	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C08Ah	PORT5	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C08Bh	PORT5	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C094h	PORTA	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C095h	PORTA	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C096h	PORTB	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C097h	PORTB	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C098h	PORTC	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C099h	PORTC	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C09Ch	PORTE	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB	2 ICLK
0008 C09Dh	PORTE	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (28/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
000A 8446h	RSCAN	Receive Rule Entry Register 13CH	GAFLPH13	16	16	2 or 3 PCLKB	2 ICLK
000A 8446h	RSCAN	Receive Buffer Register 10BH	RMPTR10	16	16	2 or 3 PCLKB	2 ICLK
000A 8448h	RSCAN	Receive Rule Entry Register 14AL	GAFLIDL14	16	16	2 or 3 PCLKB	2 ICLK
000A 8448h	RSCAN	Receive Buffer Register 10CL	RMDF010	16	16	2 or 3 PCLKB	2 ICLK
000A 844Ah	RSCAN	Receive Rule Entry Register 14AH	GAFLIDH14	16	16	2 or 3 PCLKB	2 ICLK
000A 844Ah	RSCAN	Receive Buffer Register 10CH	RMDF110	16	16	2 or 3 PCLKB	2 ICLK
000A 844Ch	RSCAN	Receive Rule Entry Register 14BL	GAFLML14	16	16	2 or 3 PCLKB	2 ICLK
000A 844Ch	RSCAN	Receive Buffer Register 10DL	RMDF210	16	16	2 or 3 PCLKB	2 ICLK
000A 844Eh	RSCAN	Receive Rule Entry Register 14BH	GAFLMH14	16	16	2 or 3 PCLKB	2 ICLK
000A 844Eh	RSCAN	Receive Buffer Register 10DH	RMDF310	16	16	2 or 3 PCLKB	2 ICLK
000A 8450h	RSCAN	Receive Rule Entry Register 14CL	GAFLPL14	16	16	2 or 3 PCLKB	2 ICLK
000A 8450h	RSCAN	Receive Buffer Register 11AL	RMIDL11	16	16	2 or 3 PCLKB	2 ICLK
000A 8452h	RSCAN	Receive Rule Entry Register 14CH	GAFLPH14	16	16	2 or 3 PCLKB	2 ICLK
000A 8452h	RSCAN	Receive Buffer Register 11AH	RMIDH11	16	16	2 or 3 PCLKB	2 ICLK
000A 8454h	RSCAN	Receive Rule Entry Register 15AL	GAFLIDL15	16	16	2 or 3 PCLKB	2 ICLK
000A 8454h	RSCAN	Receive Buffer Register 11BL	RMTS11	16	16	2 or 3 PCLKB	2 ICLK
000A 8456h	RSCAN	Receive Rule Entry Register 15AH	GAFLIDH15	16	16	2 or 3 PCLKB	2 ICLK
000A 8456h	RSCAN	Receive Buffer Register 11BH	RMPTR11	16	16	2 or 3 PCLKB	2 ICLK
000A 8458h	RSCAN	Receive Rule Entry Register 15BL	GAFLML15	16	16	2 or 3 PCLKB	2 ICLK
000A 8458h	RSCAN	Receive Buffer Register 11CL	RMDF011	16	16	2 or 3 PCLKB	2 ICLK
000A 845Ah	RSCAN	Receive Rule Entry Register 15BH	GAFLMH15	16	16	2 or 3 PCLKB	2 ICLK
000A 845Ah	RSCAN	Receive Buffer Register 11CH	RMDF111	16	16	2 or 3 PCLKB	2 ICLK
000A 845Ch	RSCAN	Receive Rule Entry Register 15CL	GAFLPL15	16	16	2 or 3 PCLKB	2 ICLK
000A 845Ch	RSCAN	Receive Buffer Register 11DL	RMDF211	16	16	2 or 3 PCLKB	2 ICLK
000A 845Eh	RSCAN	Receive Rule Entry Register 15CH	GAFLPH15	16	16	2 or 3 PCLKB	2 ICLK
000A 845Eh	RSCAN	Receive Buffer Register 11DH	RMDF311	16	16	2 or 3 PCLKB	2 ICLK
000A 8460h	RSCAN	Receive Buffer Register 12AL	RMIDL12	16	16	2 or 3 PCLKB	2 ICLK
000A 8462h	RSCAN	Receive Buffer Register 12AH	RMIDH12	16	16	2 or 3 PCLKB	2 ICLK
000A 8464h	RSCAN	Receive Buffer Register 12BL	RMTS12	16	16	2 or 3 PCLKB	2 ICLK
000A 8466h	RSCAN	Receive Buffer Register 12BH	RMPTR12	16	16	2 or 3 PCLKB	2 ICLK
000A 8468h	RSCAN	Receive Buffer Register 12CL	RMDF012	16	16	2 or 3 PCLKB	2 ICLK
000A 846Ah	RSCAN	Receive Buffer Register 12CH	RMDF112	16	16	2 or 3 PCLKB	2 ICLK
000A 846Ch	RSCAN	Receive Buffer Register 12DL	RMDF212	16	16	2 or 3 PCLKB	2 ICLK
000A 846Eh	RSCAN	Receive Buffer Register 12DH	RMDF312	16	16	2 or 3 PCLKB	2 ICLK
000A 8470h	RSCAN	Receive Buffer Register 13AL	RMIDL13	16	16	2 or 3 PCLKB	2 ICLK
000A 8472h	RSCAN	Receive Buffer Register 13AH	RMIDH13	16	16	2 or 3 PCLKB	2 ICLK
000A 8474h	RSCAN	Receive Buffer Register 13BL	RMTS13	16	16	2 or 3 PCLKB	2 ICLK
000A 8476h	RSCAN	Receive Buffer Register 13BH	RMPTR13	16	16	2 or 3 PCLKB	2 ICLK
000A 8478h	RSCAN	Receive Buffer Register 13CL	RMDF013	16	16	2 or 3 PCLKB	2 ICLK
000A 847Ah	RSCAN	Receive Buffer Register 13CH	RMDF113	16	16	2 or 3 PCLKB	2 ICLK
000A 847Ch	RSCAN	Receive Buffer Register 13DL	RMDF213	16	16	2 or 3 PCLKB	2 ICLK
000A 847Eh	RSCAN	Receive Buffer Register 13DH	RMDF313	16	16	2 or 3 PCLKB	2 ICLK
000A 8480h	RSCAN	Receive Buffer Register 14AL	RMIDL14	16	16	2 or 3 PCLKB	2 ICLK
000A 8482h	RSCAN	Receive Buffer Register 14AH	RMIDH14	16	16	2 or 3 PCLKB	2 ICLK
000A 8484h	RSCAN	Receive Buffer Register 14BL	RMTS14	16	16	2 or 3 PCLKB	2 ICLK
000A 8486h	RSCAN	Receive Buffer Register 14BH	RMPTR14	16	16	2 or 3 PCLKB	2 ICLK
000A 8488h	RSCAN	Receive Buffer Register 14CL	RMDF014	16	16	2 or 3 PCLKB	2 ICLK
000A 848Ah	RSCAN	Receive Buffer Register 14CH	RMDF114	16	16	2 or 3 PCLKB	2 ICLK
000A 848Ch	RSCAN	Receive Buffer Register 14DL	RMDF214	16	16	2 or 3 PCLKB	2 ICLK
000A 848Eh	RSCAN	Receive Buffer Register 14DH	RMDF314	16	16	2 or 3 PCLKB	2 ICLK
000A 8490h	RSCAN	Receive Buffer Register 15AL	RMIDL15	16	16	2 or 3 PCLKB	2 ICLK
000A 8492h	RSCAN	Receive Buffer Register 15AH	RMIDH15	16	16	2 or 3 PCLKB	2 ICLK

5.2 DC Characteristics

Table 5.3 DC Characteristics (1)

Conditions: 2.7 V ≤ VCC = VCC_USB ≤ 5.5 V, 2.7 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	RIIC input pin (except for SMBus, 5 V tolerant)		V_{IH}	VCC × 0.7	—	5.8	V	
	Ports 12, 13, 16, 17, port B5 (5 V tolerant)			VCC × 0.8	—	5.8		
	Ports 14 to 15, ports 20 to 27, ports 33 to 37, ports 50 to 55, ports A0 to A7, ports B0 to B4, B6, B7 ports C0 to C7, ports D0 to D7, ports E0 to E7, port J3, Ports 30 to 32 (when time capture event input is not selected), RES#			VCC × 0.8	—	VCC + 0.3		
	Ports 03, 05, 07, ports 40 to 47			AVCC0 × 0.8	—	AVCC0 + 0.3		
	Ports 30 to 32 (when time capture event input is selected)	When VCC is supplied		VCC × 0.8	—	VCC + 0.3		
		When VBATT is supplied		VBATT × 0.8	—	VBATT + 0.3		
	Ports 03, 05, 07, ports 40 to 47		V_{IL}	–0.3	—	AVCC0 × 0.2		
	RIIC input pin (except for SMBus)			–0.3	—	VCC × 0.3		
	Other than RIIC input pin or ports 30 to 32			–0.3	—	VCC × 0.2		
	Ports 30 to 32 (when time capture event input is selected)	When VCC is supplied		–0.3	—	VCC × 0.3		
		When VBATT is supplied		–0.3	—	VBATT × 0.3		
	Ports 03, 05, 07, ports 40 to 47		ΔV_T	AVCC0 × 0.1	—	—		
	RIIC input pin (except for SMBus)			VCC × 0.05	—	—		
	Ports 12, 13, 16, 17, Port B5			VCC × 0.05	—	—		
	Other than RIIC input pin			VCC × 0.1	—	—		
Input level voltage (except for Schmitt trigger input pins)	MD		V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL (external clock input)			VCC × 0.8	—	VCC + 0.3		
	RIIC input pin (SMBus)			2.1	—	VCC + 0.3		
	MD		V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL (external clock input)			–0.3	—	VCC × 0.2		
	RIIC input pin (SMBus)			–0.3	—	0.8		

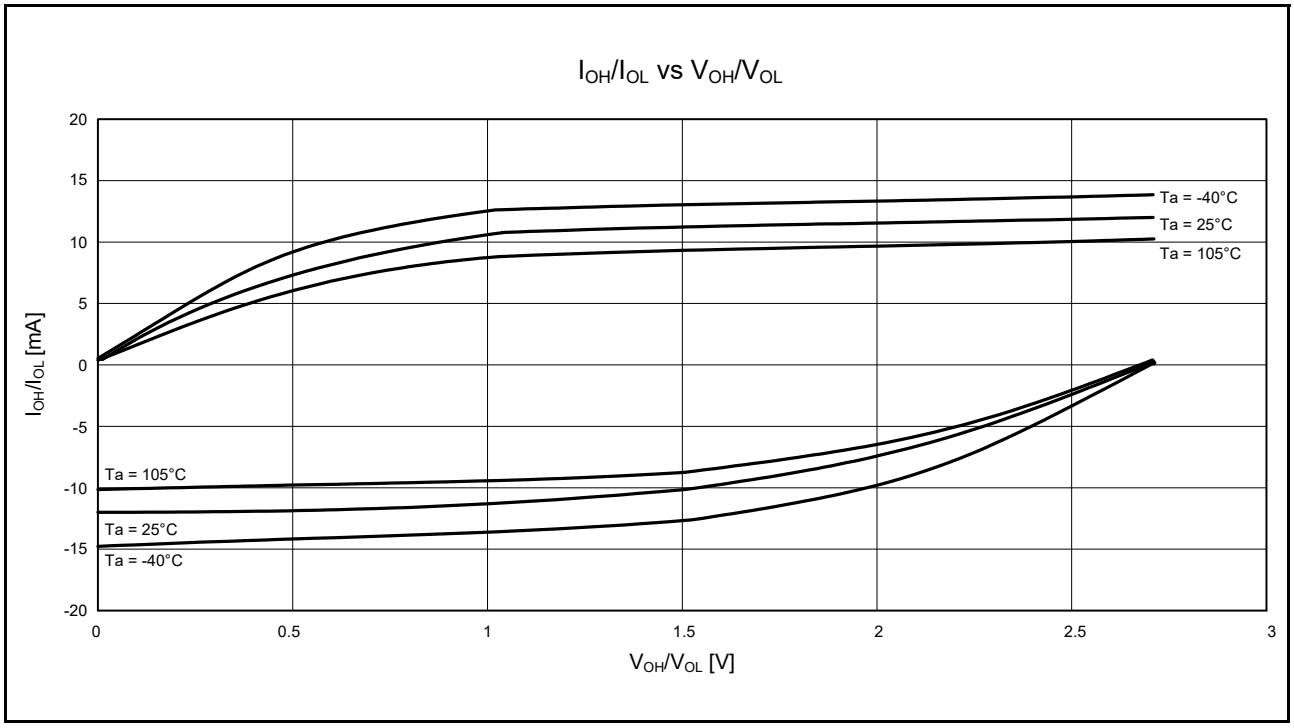


Figure 5.10 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 2.7 V When Normal Output is Selected (Reference Data)

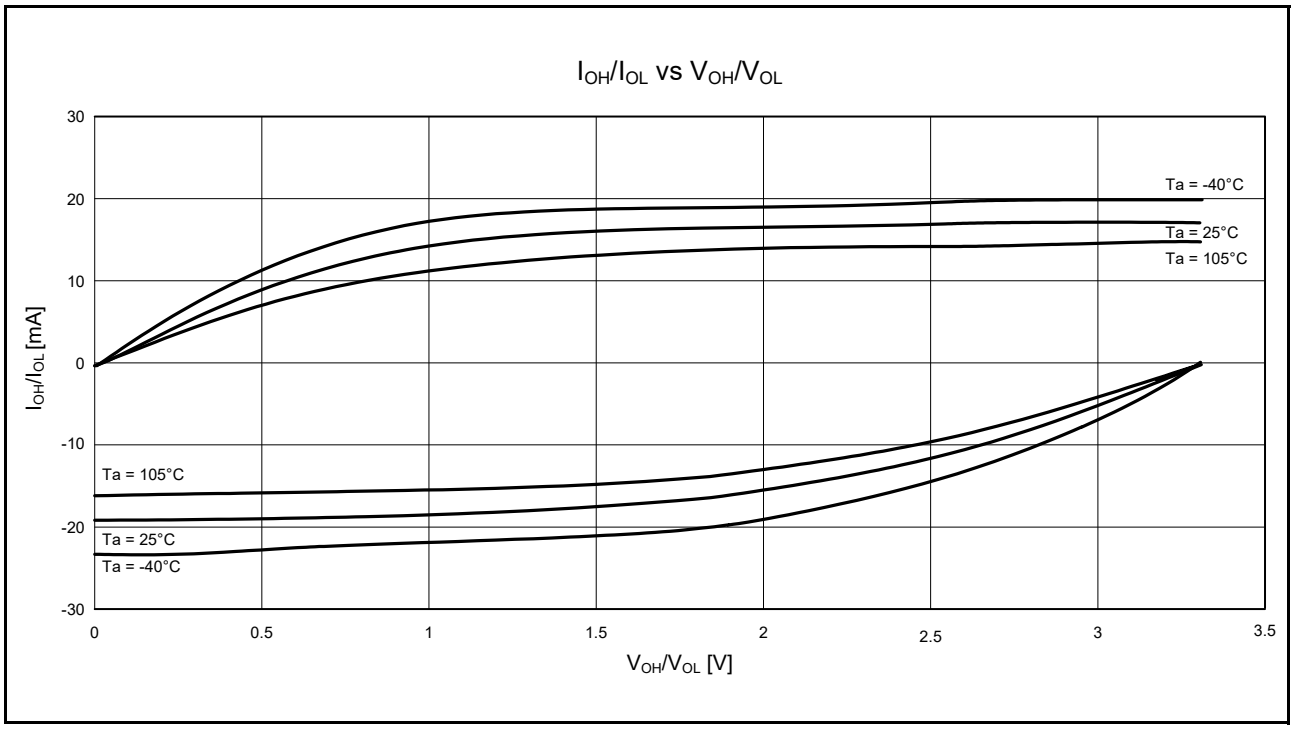


Figure 5.11 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 3.3 V When Normal Output is Selected (Reference Data)

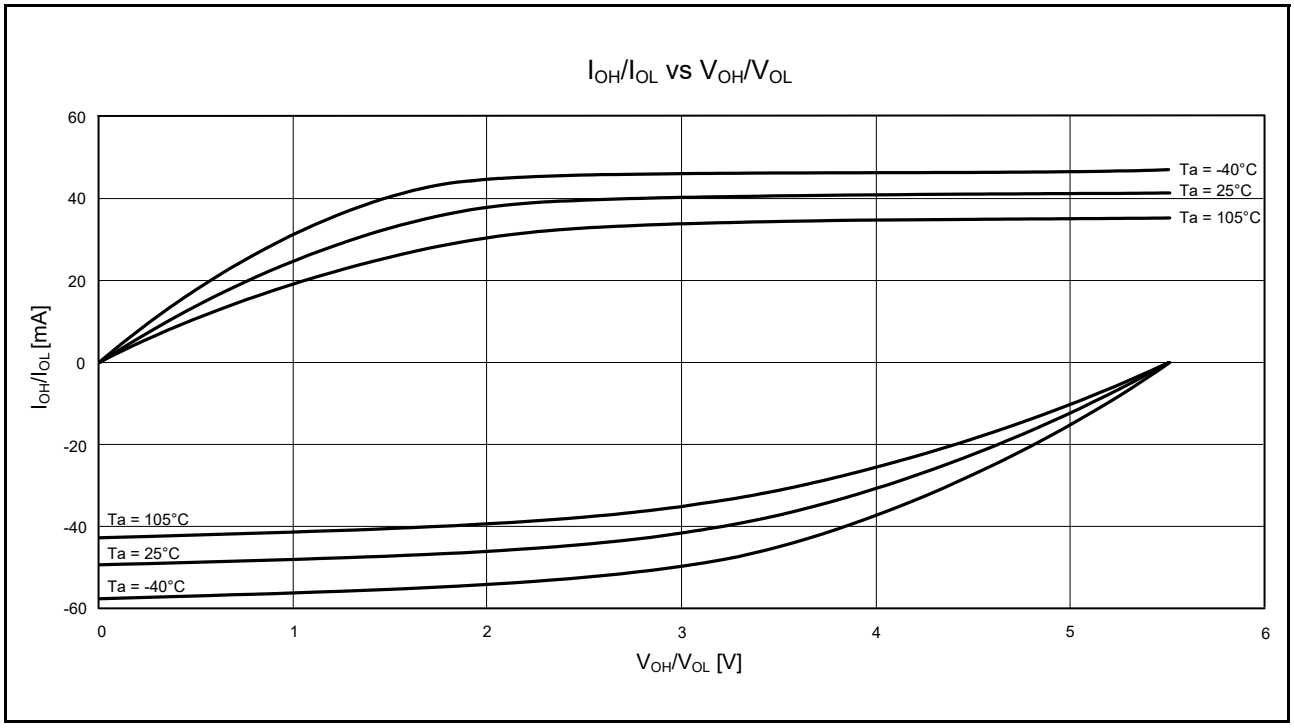


Figure 5.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 5.5 V When Normal Output is Selected (Reference Data)

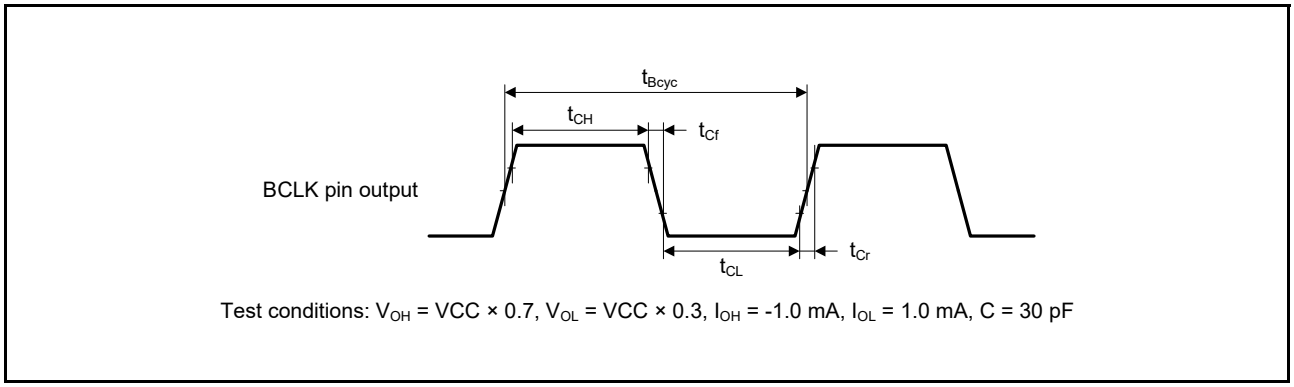


Figure 5.22 BCLK Pin Output Timing

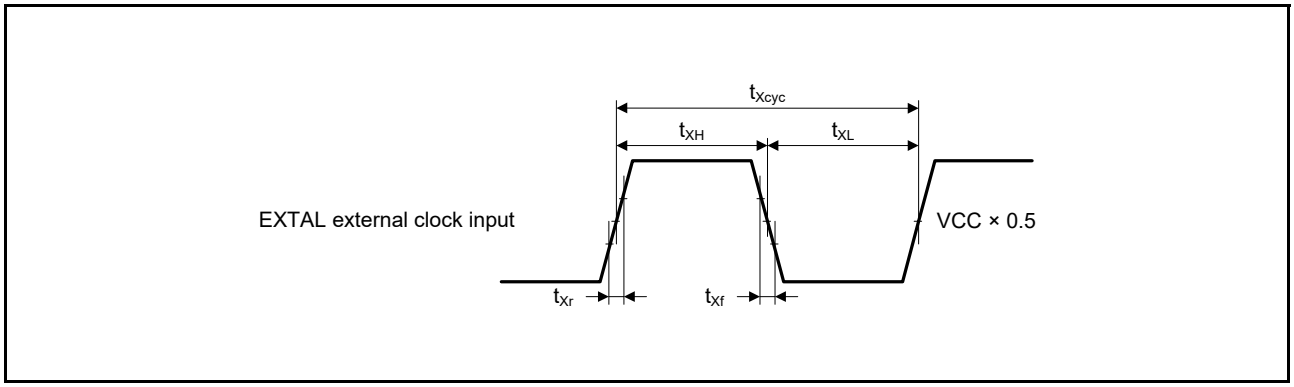


Figure 5.23 EXTAL External Clock Input Timing

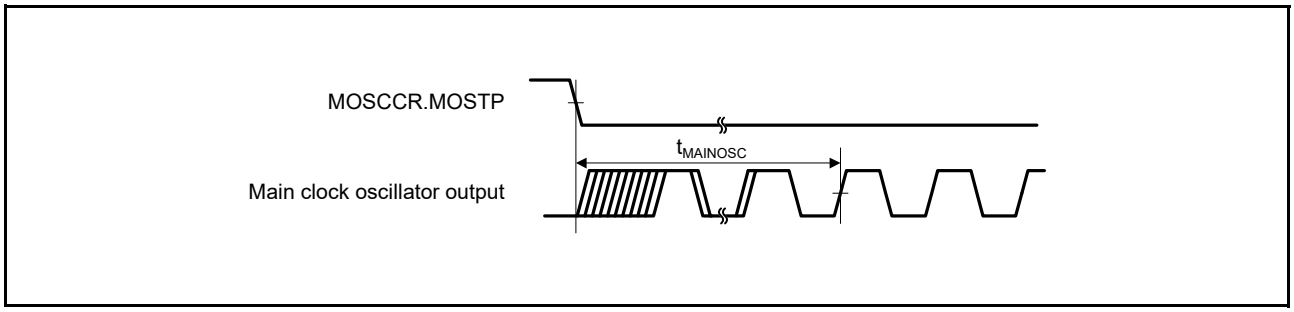


Figure 5.24 Main Clock Oscillation Start Timing

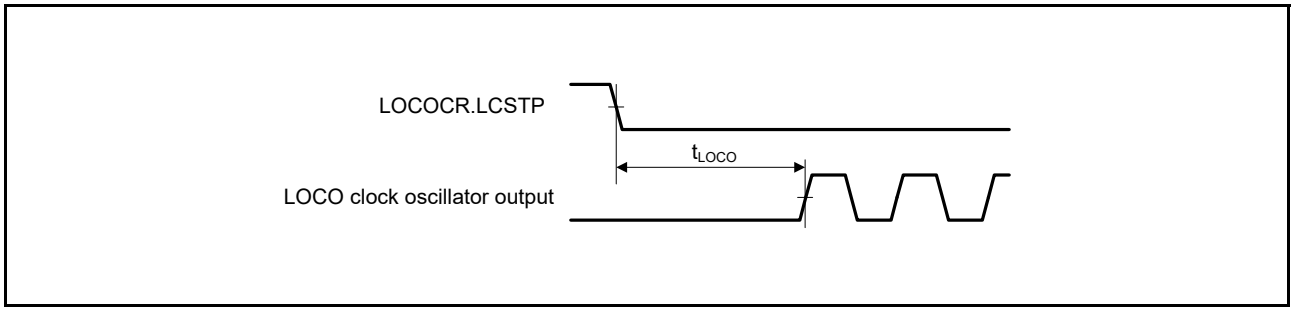


Figure 5.25 LOCO Clock Oscillation Start Timing

Table 5.40 Timing of On-Chip Peripheral Modules (3)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)		t_{SPcyc}	4	65536	t_{Pcyc}	Figure 5.54
	SCK clock cycle input (slave)			6	65536	t_{Pcyc}	
	SCK clock high pulse width		t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width		t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time		t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time (master)	2.7 V or above	t_{SU}	65	—	ns	Figure 5.55, Figure 5.56
		1.8 V or above		95	—		
	Data input setup time (slave)			40	—		
	Data input hold time		t_H	40	—	ns	
	SSL input setup time		t_{LEAD}	3	—	t_{SPcyc}	
	SSL input hold time		t_{LAG}	3	—	t_{SPcyc}	
	Data output delay time (master)		t_{OD}	—	40	ns	
	Data output delay time (slave)	2.7 V or above		—	65		
		1.8 V or above		—	100		
	Data output hold time (master)	2.7 V or above	t_{OH}	–10	—	ns	
		1.8 V or above		–20	—		
	Data output hold time (slave)			–10	—		
	Data rise/fall time		t_{Dr}, t_{Df}	—	20	ns	
	SSL input rise/fall time		t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time		t_{SA}	—	6	t_{Pcyc}	Figure 5.57, Figure 5.58
	Slave output release time		t_{REL}	—	6	t_{Pcyc}	

Note 1. t_{Pcyc}: PCLK cycle

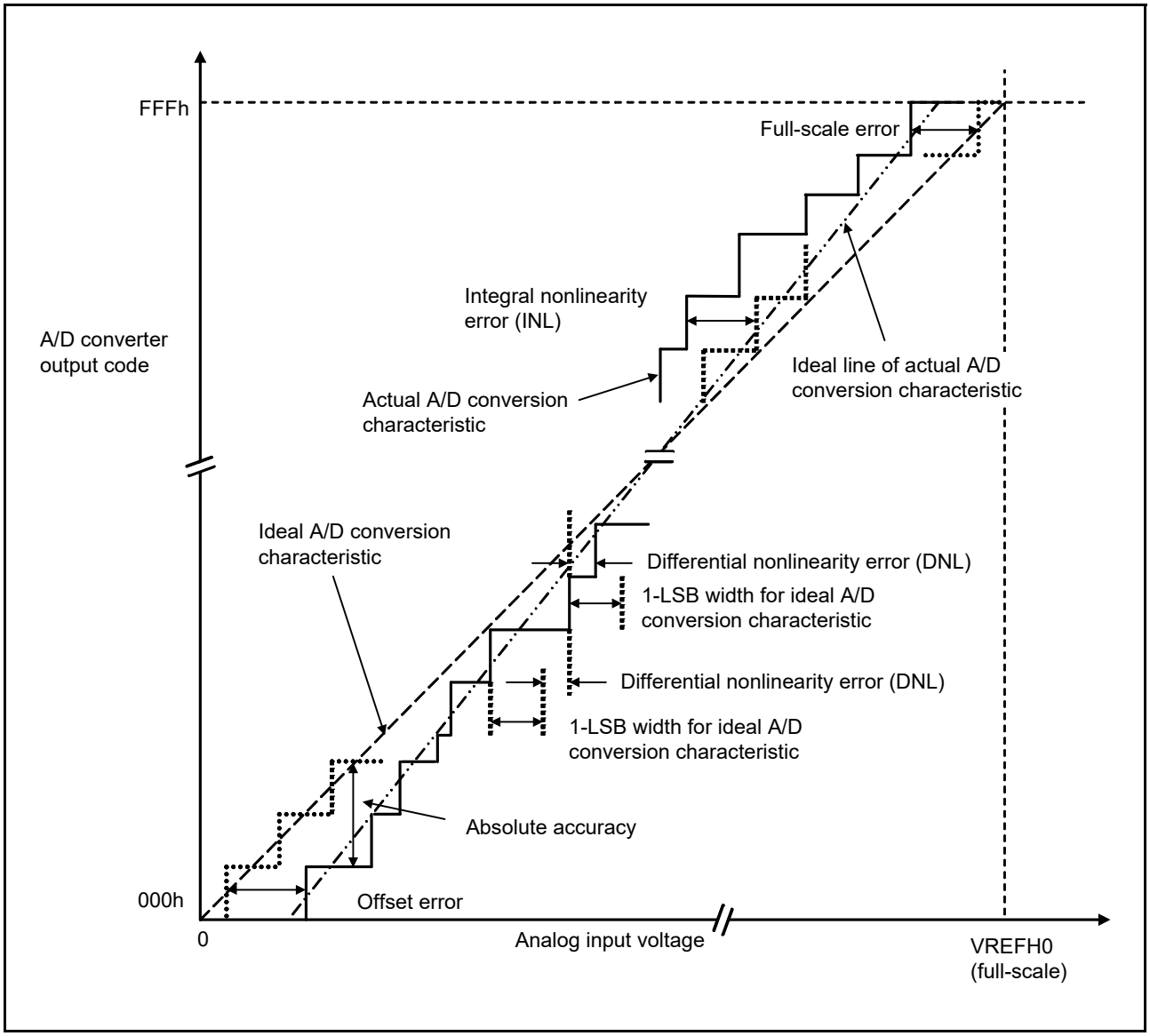


Figure 5.69 Illustration of A/D Converter Characteristic Terms

Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics and the actual A/D conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage (VREFH0 = 3.072 V), then 1-LSB width becomes 0.75 mV, and 0 mV, 0.75 mV, 1.5 mV, ... are used as analog input voltages.

If analog input voltage is 6 mV, absolute accuracy = ±5 LSB means that the actual A/D conversion result is in the range of 003h to 00Dh, although an output code, 008h, can be expected from the theoretical A/D conversion characteristics.

Integral non-linearity error (INL)

The integral non-linearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

Table 5.59 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit (2)

Conditions: 1.8 V ≤ VCC0 = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Wait time after power-on reset cancellation	At normal startup*1	t_{POR}	—	9.1	—	ms	Figure 5.74
	During fast startup time*2	t_{POR}	—	1.6	—		
Wait time after voltage monitoring 0 reset cancellation	Power-on voltage monitoring 0 reset disabled*1	t_{LVD0}	—	568	—	µs	Figure 5.75
	Power-on voltage monitoring 0 reset enabled*2		—	100	—		
Wait time after voltage monitoring 1 reset cancellation		t_{LVD1}	—	100	—	µs	Figure 5.76
Wait time after voltage monitoring 2 reset cancellation		t_{LVD2}	—	100	—	µs	Figure 5.77
Response delay time		t_{det}	—	—	350	µs	Figure 5.73
Minimum VCC down time*3		t_{VOFF}	350	—	—	µs	Figure 5.73, VCC = 1.0 V or above
Power-on reset enable time		$t_{W(POR)}$	1	—	—	ms	Figure 5.74, VCC = below 1.0 V
LVD operation stabilization time (after LVD is enabled)		$Td_{(E-A)}$	—	—	300	µs	Figure 5.76, Figure 5.77
Hysteresis width (power-on rest (POR))		V_{PORH}	—	110	—	mV	
Hysteresis width (voltage detection circuit: LVD1 and LVD2)		V_{LVH}	—	70	—	mV	When Vdet1_0 to Vdet1_4 is selected
			—	60	—		When Vdet1_5 to Vdet1_9 is selected
			—	50	—		When Vdet1_A or Vdet1_B is selected
			—	40	—		When Vdet1_C or Vdet1_D is selected
			—	60	—		When LVD2 is selected

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. When OFS1.(LVDAS, FASTSTUP) = 11b.

Note 2. When OFS1.(LVDAS, FASTSTUP) ≠ 11b.

Note 3. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det0}, V_{det1}, and V_{det2} for the POR/LVD.

5.14 E2 DataFlash Characteristics (Flash Memory for Data Storage)

Table 5.65 E2 DataFlash Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1		N_{DPEC}	100000	1000000	—	Times	
Data hold time	After 10000 times of N_{DPEC}	t_{DDRP}	20*2, *3	—	—	Year	T_a = +85°C
	After 100000 times of N_{DPEC}		5*2, *3	—	—	Year	
	After 1000000 times of N_{DPEC}		—	1*2, *3	—	Year	T_a = +25°C

Note 1. The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 1-byte programming is performed 1000 times for different addresses in a 1-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. Characteristic when the flash memory programmer is used and the self-programming library is provided from Renesas Electronics.
Note 3. These results are obtained from reliability testing.

Table 5.66 E2 DataFlash Characteristics (2) : high-speed operating mode

Conditions: 2.7 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1 byte	t_{DP1}	—	95.0	797	—	40.8	376	µs
Erasure time	1 Kbyte	t_{DE1K}	—	19.5	498	—	6.2	230	ms
	8 Kbyte	t_{DE8K}	—	119.8	2556	—	12.9	368	ms
Blank check time	1 byte	t_{DBC1}	—	—	55.00	—	—	16.1	µs
	1 Kbyte	t_{DBC1K}	—	—	0.72	—	—	0.50	ms
Erase operation forced stop time		t_{DSED}	—	—	16.0	—	—	10.7	µs
DataFlash STOP recovery time		t_{DSTOP}	5.0	—	—	5.0	—	—	µs

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within ±3.5%.

Table 5.67 E2 DataFlash Characteristics (3) : middle-speed operating mode

Conditions: 1.8 V ≤ VCC0 = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = –40 to +85°C

Item		Symbol	FCLK = 1 MHz			FCLK = 8 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1 byte	t_{DP1}	—	135	1197	—	86.5	823	µs
Erasure time	1 Kbyte	t_{DE1K}	—	19.6	501	—	8.0	265	ms
	8 Kbyte	t_{DE8K}	—	120	2558		27.7	669	ms
Blank check time	1 byte	t_{DBC1}	—	—	85.0	—	—	50.9	µs
	1 Kbyte	t_{DBC1K}	—	—	0.72	—	—	1.45	ms
Erase operation forced stop time		t_{DSED}	—	—	28.0	—	—	21.3	µs
DataFlash STOP recovery time		t_{DSTOP}	0.72	—	—	0.72	—	—	µs

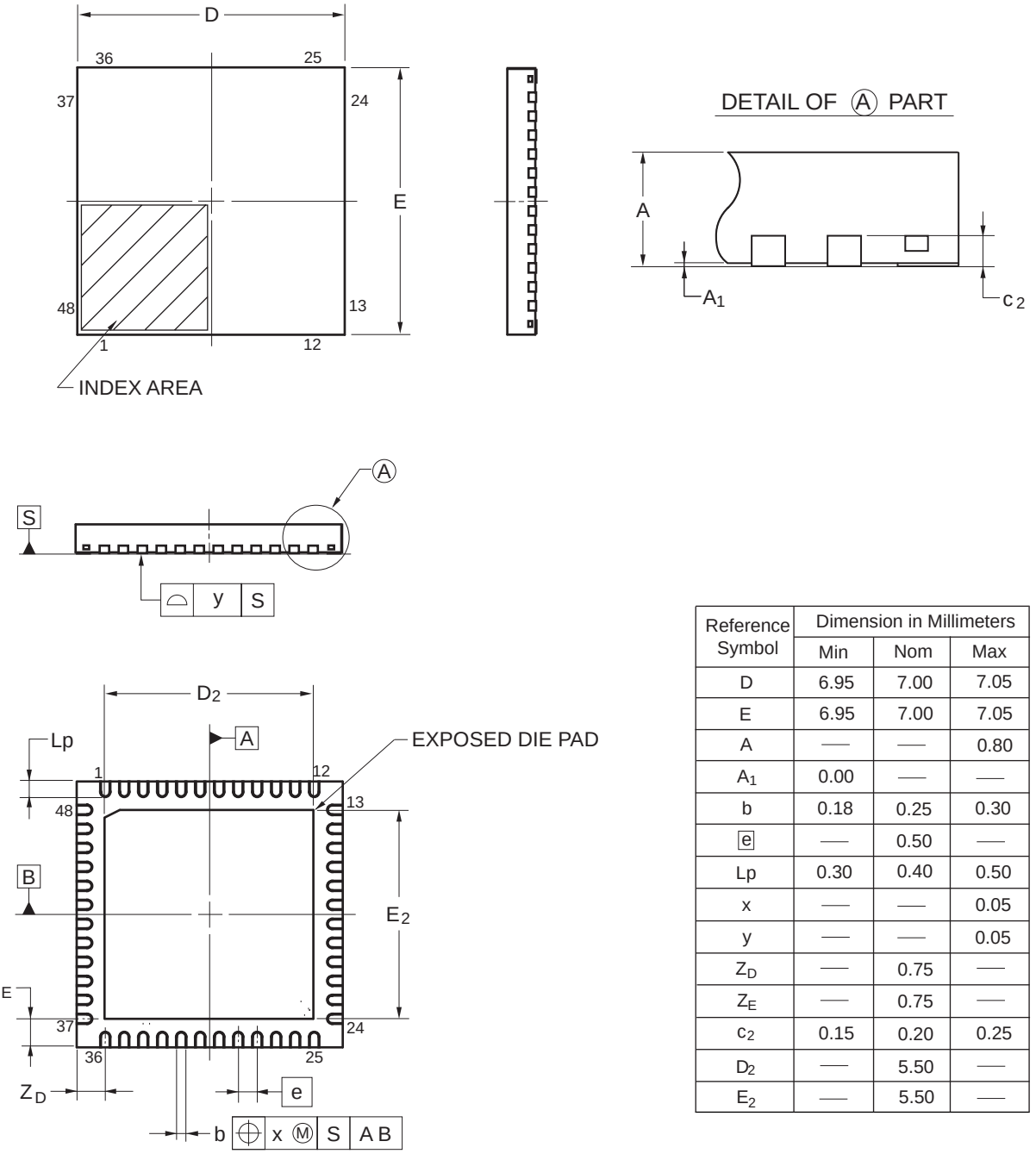
Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within ±3.5%.

5.15 Usage Notes

5.15.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU automatically to the optimum level. A 4.7-µF capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and the VSS pin. Figure 5.80 to Figure 5.82 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin.
Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor as closer to the MCU power supply pins as possible. Use a recommended value of 0.1 µF as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 43, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.
For notes on designing the printed circuit board, see the descriptions of the application note, the Hardware Design Guide (R01AN1411EJ). The latest version can be downloaded from the Renesas Electronics website.

JEITA Package code	RENESAS code	Previous code	MASS(TYP.)[g]
P-HWQFN48-7x7-0.50	PWQN0048KB-A	48PJN-A P48K8-50-5B4-7	0.13



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	6.95	7.00	7.05
E	6.95	7.00	7.05
A	—	—	0.80
A_1	0.00	—	—
b	0.18	0.25	0.30
e	—	0.50	—
Lp	0.30	0.40	0.50
x	—	—	0.05
y	—	—	0.05
Z_D	—	0.75	—
Z_E	—	0.75	—
c_2	0.15	0.20	0.25
D_2	—	5.50	—
E_2	—	5.50	—

Figure F 48 -Pin HWQFN (PWQN0048KB-A)

Rev.	Date	Description		Classification
		Page	Summary	
1.10	Oct 30, 2015	142	Table 5.45 A/D Conversion Characteristics (1): Conditions and Voltage Range of Analog Input (Max.), changed	
		143	Table 5.46 A/D Conversion Characteristics (2): Conditions changed	
		144	Table 5.47 A/D Conversion Characteristics (3): Conditions changed	
		145	Table 5.48 A/D Conversion Characteristics (4): Conditions changed	
		146	Table 5.49 A/D Conversion Characteristics (5): Conditions changed and Absolute accuracy (Test Conditions) deleted	
		153	Table 5.57 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit (1), changed	TN-RX*-A137A/E
		154	Table 5.58 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit (2), changed	
		155	Figure 5.73 Power-On Reset Timing and Figure 5.74 Voltage Detection Circuit Timing (Vdet0), changed	
		159	Table 5.62 ROM (Flash Memory for Code Storage) Characteristics (2) High-Speed Operating Mode: Note changed	
		160	Table 5.63 ROM (Flash Memory for Code Storage) Characteristics (3) Middle-Speed Operating Mode: Note changed	
		161	Table 5.65 E2 DataFlash Characteristics (2): high-speed operating mode, Note changed	
		161	Table 5.66 E2 DataFlash Characteristics (3): middle-speed operating mode, Conditions and Note changed	
		163	Figure 5.79 Connecting Capacitors (100 Pins), changed	
		164	Figure 5.80 Connecting Capacitors (64 Pins), changed	
		165	Figure 5.81 Connecting Capacitors (48 Pins), changed	
		Appendix 1. Package Dimensions		
		167	Figure B 100 -Pin LQFP (PLQP0100KB-B), changed	TN-RX*-A137A/E
		170	Figure E 64 -Pin LQFP (PLQP0064KB-C), changed	TN-RX*-A137A/E
		172	Figure G 48 -Pin LQFP (PLQP0048KB-B), changed	TN-RX*-A137A/E
1.20	Sep 28, 2018	Features		
		1	SD host interface (optional: one channel) SD memory/ SDIO 1-bit or 4-bit SD bus supported, Note deleted	TN-RX*-A145A/E
		1. Overview		
		6	Table 1.2 Comparison of Functions for Different Packages, changed (deletion of IRQ2 on 64-pin package)	
		6	Table 1.2 Comparison of Functions for Different Packages, Note 1 added	TN-RX*-A145A/E
		7	Table 1.3 List of Products: D Version (Ta = –40 to +85°C) (1/2), changed	TN-RX*-A145A/E
		9	Table 1.4 List of Products: G Version (Ta = –40 to +105°C) (1/2), changed	TN-RX*-A145A/E
		11	Figure 1.1 How to Read the Product Part Number, changed	TN-RX*-A145A/E
		16	Table 1.5 Pin Functions (4/4), changed (changes in description for VCC_USB)	TN-RX*-A201A/E
		24	Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (2/3), changed (UPSEL was added to the column of P35)	
		24	Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (2/3), changed (USB0_VBUS was added to the column of PB5)	
		26	Table 1.7 List of Pins and Pin Functions (100-Pin LFQFP) (1/3), changed (UPSEL was added to the column of P35)	
		29	Table 1.8 List of Pins and Pin Functions (64-Pin WFLGA) (1/2), changed (UPSEL was added to the column of P35)	
		30	Table 1.8 List of Pins and Pin Functions (64-Pin WFLGA) (2/2), changed (USB0_VBUS was added to the column of PB5)	
		31	Table 1.9 List of Pins and Pin Functions (64-Pin LFQFP/HWQFN) (1/2), changed (UPSEL was added to the column of P35)	
		31	Table 1.9 List of Pins and Pin Functions (64-Pin LQFP/HWQFN) (1/2), changed (USB0_VBUS was added to the column of PB5)	
		33	Table 1.10 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (1/2), changed (UPSEL was added to the column of P35)	
		33	Table 1.10 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (1/2), changed	TN-RX*-A145A/E
		5. Electrical Characteristics		
		92	Table 5.18 Output Values of Voltage (1), changed	TN-RX*-A201A/E
		92	Table 5.19 Output Values of Voltage (2), changed	TN-RX*-A201A/E